

**MOSFET MODULE****FCA75CC50**

TOP

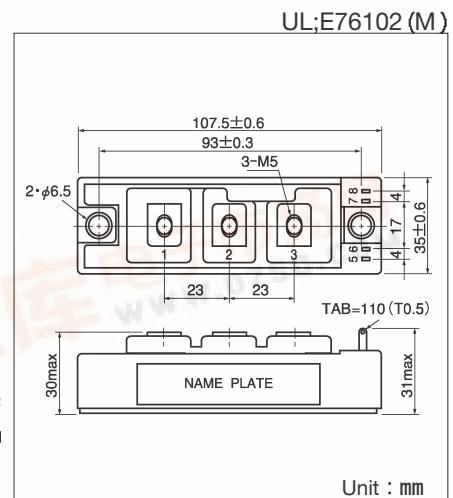
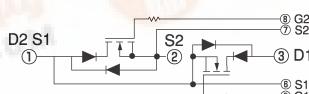


**FCA75CC50** is a dual power MOSFET module designed for fast switching applications of high voltage and current. (2 devices are serial connected.) The mounting base of the module is electrically isolated from semiconductor elements for simple heatsink construction.

- $I_D = 75A$ ,  $V_{DSS} = 500V$
- Suitable for high speed switching applications.
- Low ON resistance.
- Wide Safe Operating Areas.
- $t_{rr} \leq 100ns$

## (Applications)

UPS(CVCF), Motor Control, Switching Power Supply, etc.

**■ Maximum Ratings**(T<sub>j</sub>=25°C)

Symbol	Item	Conditions	Ratings		Unit
			FCA75CC50		
V <sub>DSS</sub>	Drain-Source Voltage		500		V
V <sub>GSS</sub>	Gate-Source Voltage		±20		V
I <sub>D</sub>	Drain Current	DC	75		A
	Pulse		150		
I <sub>S</sub>	Source Current		75		A
P <sub>T</sub>	Total Power Dissipation	T <sub>c</sub> =25°C	430		W
T <sub>j</sub>	Channel Temperature		−40~+150		°C
T <sub>stg</sub>	Storage Temperature		−40~+125		°C
V <sub>iso</sub>	Isolation Voltage (R.M.S.)	A.C. 1 minute	2500		V
Mounting Torque	Mounting (M6)	Recommended Value 2.5~3.9 (25~40)	4.7 (48)		N·m (kgf·cm)
	Terminal (M5)	Recommended Value 1.5~2.5 (15~25)	2.7 (28)		
Mass	Typical Value		240		g

**■ Electrical Characteristics**(T<sub>j</sub>=25°C)

Symbol	Item	Conditions	Ratings			Unit	
			Min.	Typ.	Max.		
I <sub>GSS</sub>	Gate Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±1.0	μA	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>GS</sub> =0V, V <sub>DS</sub> =500V			1.0	mA	
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =1mA	500			V	
V <sub>GS(th)</sub>	Gate-Source Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =10mA	1.0		5.0	V	
R <sub>D(on)</sub>	Drain-Source On-State Resistance	I <sub>D</sub> =40A, V <sub>GS</sub> =15V			140	mΩ	
V <sub>D(on)</sub>	Drain-Source On-State Voltage	I <sub>D</sub> =40A, V <sub>GS</sub> =15V			3.5	V	
g <sub>f</sub>	Forward Transconductance	V <sub>DS</sub> =10V, I <sub>D</sub> =40A		40		S	
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz			13500	pF	
C <sub>oss</sub>	Output Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz			2500	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1.0MHz			1000	pF	
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =300V, V <sub>GS</sub> =15V I <sub>D</sub> =40A, R <sub>G</sub> =5Ω		60		ns	
				60			
	Rise Time			650			
				130			
t <sub>d(off)</sub>	Turn-off Delay Time					ns	
	Fall Time						
V <sub>SDS</sub>	Diode Forward Voltage	I <sub>S</sub> =40A, V <sub>GS</sub> =0V			2.5	V	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>S</sub> =40A, V <sub>GS</sub> =−5V, di/dt=100A/μs		80	100	ns	
R <sub>th(j-c)</sub>	Thermal Resistance	MOSFET			0.29	°C/W	
		Diode			1.67		

